

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HOJUN MOON	07/10/2015
BONKEE KIM	07/10/2015
SEYEOB KIM	07/10/2015
SANGSIC YOON	07/10/2015
SUNYOUNG KWON	07/10/2015
TAEHOON KIM	07/10/2015
RECEIVING PARTY DATA	
Name:	HIDEEP INC.
Street Address:	3F DASAN TOWER, 49, DAEWANGPANGYO-RO 644 BEON-GIL
Internal Address:	676 SAMPYEONG-DONG, BUNDANG-GU, SEONGNAM-SI
City:	GYEONGGI-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	463-400
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14992403
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	KNP-151-US-CON
NAME OF SUBMITTER:	MICHELE GREENBERG
SIGNATURE:	/mg/
DATE SIGNED:	01/11/2016

Total Attachments: 2

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ASSIGNMENT & DECLARATION

WHEREAS, We, Hojun Moon, Bonkee Kim, Seyeob Kim, Sangsic Yoon, Sunyoung Kwon, and Taehoon Kim (hereinafter the "Assignors"), residing at c/o 3F Dasan Tower, 49, Daewangpangyo-ro 644 beon-gil, 676 Sampyeong-dong, Bundang-gu, Seongnam-si, Gyeonggi-do 463-400, Republic of Korea (respectively), believe we are the original joint inventors of certain inventions or improvements claimed and/or disclosed in an application(s) for Letters Patent which we have made, entitled ELECTRODE SHEET AND TOUCH INPUT DEVICE, filed concurrently herewith; and

WHEREAS, the above-identified application was made or authorized to be made by us.

WHEREAS, we hereby acknowledge that any willful false statement made in this Assignment & Declaration is punishable under 18 U.S.C 1001 by fine or imprisonment of not more than five (5) years, or both.

WHEREAS, HiDeep Inc. (hereinafter the "Assignee"), of 3F Dasan Tower, 49, Daewangpangyo-ro 644 beon-gil, 676 Sampyeong-dong, Bundang-gu, Seongnam-si, Gyeonggi-do 463-400, Republic of Korea, is desirous of acquiring the entire right, title and interest in and to the said inventions or improvements and in and to the said applications, and in, to and under any and all Letters Patent which may be granted on or as a result thereof in any and all countries, including the right to file, prosecute and to otherwise pursue said applications, in the name of Assignee as Applicant, and to said inventions or improvements in any and all jurisdictions.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, We, said Assignors, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over to said Assignee, the entire right, title and interest in and to said invention or improvement and said application and any and all continuations, divisionals, non-provisionals, and renewals of and substitutes for said applications, and in, to and under any and all Letters Patent which may be granted on or as a result thereof in the United States and any and all other countries, and any reissue or reissues or extension or extensions of said Letters Patent, and assign to and authorize said Assignee, to file prosecute and otherwise pursue, in the name of Assignee as Applicant, applications for Letters Patent in all countries, the same to be held and enjoyed by said Assignee, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent, respectively, may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by us had this assignment, sale and transfer not been made.

AND We hereby covenant that we have full right to convey the entire interest herein assigned and that we have not executed and will not execute any agreement in conflict herewith, and we further covenant and agree that we will each time request is made and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said inventions or improvements, said applications and said Letters Patent to said Assignee, its successors, assigns, nominees, or legal representatives, and we agree to communicate to said Assignee or to its nominees all known facts respecting said inventions or improvements, said applications and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisional, continuing, reissue and foreign applications, to make all rightful oaths, and generally to do everything possible to aid said Assignee, its successors,

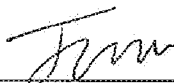
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assigns, nominees and legal representatives to obtain and enforce for its or their own benefit proper patent protection for said inventions or improvements in any and all countries, all such actions to be at the sole expense of Assignee.

AND, We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to said assignee, as assignee of the entire right, title and interest, any and all Letters Patent for said inventions or improvements, including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of the assignment.

IN WITNESS WHEREOF, We have hereunto set our hand and seal.

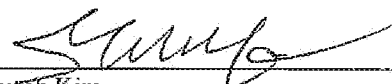
July. 10. 2015
Date


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July. 10. 2015
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Bonkee Kim
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July. 10. 2015
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Seyeob Kim
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